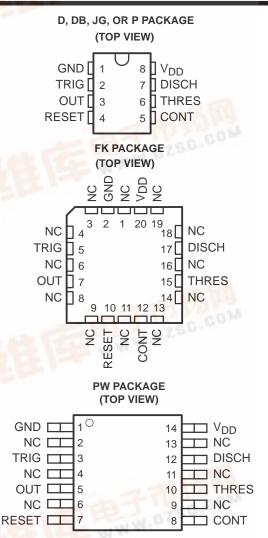
- Very Low Power Consumption
 1 mW Typ at V_{DD} = 5 V
- Capable of Operation in Astable Mode
- CMOS Output Capable of Swinging Rail to Rail
- High Output-Current Capability
 - Sink 100 mA Typ
 - Source 10 mA Typ
- Output Fully Compatible With CMOS, TTL, and MOS
- Low Supply Current Reduces Spikes During Output Transitions
- Single-Supply Operation From 2 V to 15 V
- Functionally Interchangeable With the NE555; Has Same Pinout
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015.2
- Available in Q-Temp Automotive
 High Reliability Automotive Applications
 Configuration Control/Print Support
 Qualification to Automotive Standards

description

The TLC555 is a monolithic timing circuit fabricated using the TI LinCMOS™ process. The timer is fully compatible with CMOS, TTL, and MOS logic and operates at frequencies up to 2 MHz. Because of its high input impedance, this device uses smaller timing capacitors than those used by the NE555. As a result, more accurate time delays and oscillations are possible. Power consumption is low across the full range of power supply voltage.



NC - No internal connection

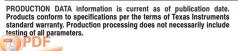
Like the NE555, the TLC555 has a trigger level equal to approximately one-third of the supply voltage and a threshold level equal to approximately two-thirds of the supply voltage. These levels can be altered by use of the control voltage terminal (CONT). When the trigger input (TRIG) falls below the trigger level, the flip-flop is set and the output goes high. If TRIG is above the trigger level and the threshold input (THRES) is above the threshold level, the flip-flop is reset and the output is low. The reset input (RESET) can override all other inputs and can be used to initiate a new timing cycle. If RESET is low, the flip-flop is reset and the output is low. Whenever the output is low, a low-impedance path is provided between the discharge terminal (DISCH) and GND. All unused inputs should be tied to an appropriate logic level to prevent false triggering.

While the CMOS output is capable of sinking over 100 mA and sourcing over 10 mA, the TLC555 exhibits greatly reduced supply-current spikes during output transitions. This minimizes the need for the large decoupling capacitors required by the NE555.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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description (continued)

The TLC555C is characterized for operation from 0° C to 70° C. The TLC555I is characterized for operation from -40° C to 85° C. The TLC555Q is characterized for operation over the automotive temperature range of -40° C to 125° C. The TLC555M is characterized for operation over the full military temperature range of -55° C to 125° C.

AVAILABLE OPTIONS[†]

| | PACKAGED DEVICES | | | | | | | | | | | |
|----------------|------------------------------|--------------------------------------|---------------------|--------------------|----------------------------|----------|-----------|--|--|--|--|--|
| TA | V _{DD} RANGE | SMALL OUTLINE (D) [‡] | CERAMIC DIP (JG) | PLASTIC DIP (P) | TSSOP (PW) [‡] | | | | | | | |
| 0°C to 70°C | 2 V to 15 V | TLC555CD | TLC555CDB | _ | _ | TLC555CP | TLC555CPW | | | | | |
| -40°C to 85°C | 3 V to 15 V | TLC555ID | _ | _ | _ | TLC555IP | _ | | | | | |
| -40°C to 125°C | 125°C 5 V to 15 V TLC555QD — | | _ | _ | _ | _ | _ | | | | | |
| -55°C to 125°C | 5 V to 15 V | TLC555MD | _ | TLC555MFK | TLC555MJG | TLC555MP | _ | | | | | |

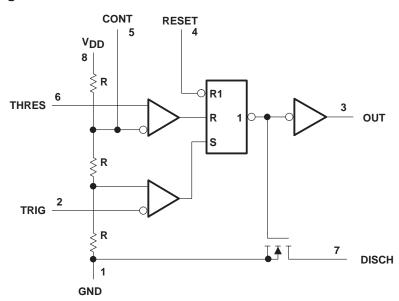
T For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

FUNCTION TABLE

| RESET VOLTAGE‡ | TRIGGER VOLTAGE‡ | THRESHOLD VOLTAGE‡ | OUTPUT | DISCHARGE SWITCH |
|--|--|--|---------|--------------------|
| <min< td=""><td>Irrelevant</td><td>Irrelevant</td><td>L</td><td>On</td></min<> | Irrelevant | Irrelevant | L | On |
| >MAX | <min< td=""><td>Irrelevant</td><td>Н</td><td>Off</td></min<> | Irrelevant | Н | Off |
| >MAX | >MAX | >MAX | L | On |
| >MAX | >MAX | <min< td=""><td>As prev</td><td>iously established</td></min<> | As prev | iously established |

[‡] For conditions shown as MIN or MAX, use the appropriate value specified under electrical characteristics.

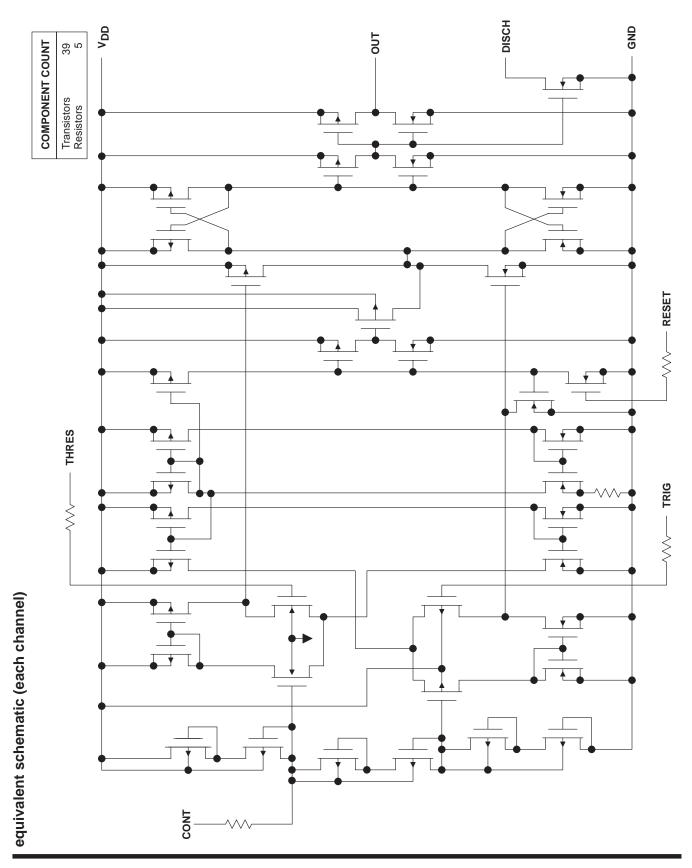
functional block diagram



Pin numbers are for all packages except the FK package. RESET can override TRIG, which can override THRES.



[‡]This package is available taped and reeled. Add the R suffix to device type (e.g., TLC555CDR).





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage, V _{DD} (see Note 1) | | 18 V |
|--|-------------------------------------|------------------------------|
| Input voltage range, V _I (any input) | | –0.3 to V _{DD} |
| Sink current, discharge or output | | 150 mA |
| Source current, output, IO | | 15 mA |
| Continuous total power dissipation | | See Dissipation Rating Table |
| Operating free-air temperature range, T _A : | C-suffix | 0°C to 70°C |
| | I-suffix | –40°C to 85°C |
| | Q-suffix | –40°C to 125°C |
| | M-suffix | –55°C to 125°C |
| Storage temperature range | | –65°C to 150°C |
| Case temperature for 60 seconds: FK pack | kage | 260°C |
| Lead temperature 1,6 mm (1/16 inch) from | case for 60 seconds: JG package | 300°C |
| Lead temperature 1,6 mm (1/16 inch) from | case for 10 seconds: D, DB, P, or I | PW package 260°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network GND.

DISSIPATION RATING TABLE

| PACKAGE | $T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING | DERATING FACTOR ABOVE T _A = 25°C | T _A = 70°C POWER RATING | T _A = 85°C POWER RATING | T _A = 125°C POWER RATING |
|---------|--|--|---------------------------------------|---------------------------------------|--|
| D | 725 mW | 5.8 mW/°C | 464 mW | 377 mW | 145 mW |
| DB | 525 mW | 4.2 mW/°C | 336 mW | 273 mW | 105 mW |
| FK | 1375 mW | 11.0 mW/°C | 880 mW | 715 mW | 275 mW |
| JG | 1050 mW | 8.4 mW/°C | 672 mW | 546 mW | 210 mW |
| Р | 1000 mW | 8.0 mW/°C | 640 mW | 520 mW | 200 mW |
| PW | 525 mW | 4.2 mW/°C | 336 mW | 273 mW | 105 mW |

recommended operating conditions

| | | MIN | MAX | UNIT |
|--|---------|-----|-----|------|
| Supply voltage, V _{DD} | | 2 | 15 | V |
| | TLC555C | 0 | 70 | |
| Operating free air temperature range T. | TLC555I | -40 | 85 | °C |
| Operating free-air temperature range, T _A | TLC555Q | -40 | 125 | -0 |
| | TLC555M | -55 | 125 | |



electrical characteristics at specified free-air temperature, V_{DD} = 2 V for TLC555C, V_{DD} = 3 V for TLC555I

| | DADAMETED | TEST | - + | 1 | LC555C | | 7 | TLC555I | | |
|------------------------|--|------------------------|------------------|------|--------|------|------|---------|-------|------------|
| | PARAMETER | CONDITIONS | T _A † | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| \/ | Three hold walks as | | 25°C | 0.95 | 1.33 | 1.65 | 1.6 | | 2.4 | V |
| VIT | Threshold voltage | | Full range | 0.85 | | 1.75 | 1.5 | | 2.5 | V |
| | Threshold current | | 25°C | | 10 | | | 10 | | » A |
| ΙΤ | Threshold current | | MAX | | 75 | | | 150 | | рA |
| \/ | Trigger veltege | | 25°C | 0.4 | 0.67 | 0.95 | 0.71 | 1 | 1.29 | V |
| V _I (TRIG) | Trigger voltage | | Full range | 0.3 | | 1.05 | 0.61 | | 1.39 | V |
| luma i a s | Trigger current | | 25°C | | 10 | | | 10 | | рA |
| l _(TRIG) | ringger current | | MAX | | 75 | | | 150 | | рА |
| \/. (= = = = ==) | Depart voltage | | 25°C | 0.4 | 1.1 | 1.5 | 0.4 | 1.1 | 1.5 | V |
| V _I (RESET) | Reset voltage | | Full range | 0.3 | | 2 | 0.3 | | 1.8 | V |
| | Donat current | | 25°C | | 10 | | | 10 | | ~ Λ |
| I(RESET) | Reset current | | MAX | | 75 | | | 150 | | pA |
| | Control voltage (open circuit) as a percentage of supply voltage | | MAX | | 66.7% | | | 66.7% | | |
| | Discharge switch on-stage | 1 4 4 | 25°C | | 0.03 | 0.2 | | 0.03 | 0.2 | V |
| | voltage | I _{OL} = 1 mA | Full range | | | 0.25 | | | 0.375 | V |
| | Discharge switch off-stage | | 25°C | | 0.1 | | | 0.1 | | A |
| | current | | MAX | | 0.5 | | | 120 | | nA |
| ., | Libe level autout valtage | 2004 | 25°C | 1.5 | 1.9 | | 2.5 | 2.85 | | V |
| VOH | High-level output voltage | $I_{OH} = -300 \mu A$ | Full range | 1.5 | | | 2.5 | | | V |
| \/-· | Low lovel output voltage | 1 1 1 | 25°C | | 0.07 | 0.3 | | 0.07 | 0.3 | V |
| VOL | Low-level output voltage | I _{OL} = 1 mA | Full range | | | 0.35 | | | 0.4 | V |
| Inn | Supply current | See Note 2 | 25°C | | | 250 | | | 250 | μА |
| IDD | Зарріу сапені | Jee Note 2 | Full range | | | 400 | | | 500 | μΑ |

[†] Full range is 0°C to 70°C for the TLC555C and –40°C to 85°C for the TLC555I. For conditions shown as MAX, use the appropriate value specified in the recommended operating conditions table.

NOTE 2: These values apply for the expected operating configurations in which THRES is connected directly to DISCH or to TRIG.

SLFS ISEPTEMBER 1/08 4 REVISED FEBRUARY 2005

electrical characteristics at specified free-air temperature, $V_{DD} = 5 V$

| _ | | TEST | - + | 1 | LC555C | | - | TLC555I | | TLC55 | 5Q, TLC | 555M | |
|------------------------|--|---------------------------|------------------|------|--------|------|------|---------|------|-------|---------|------|------|
| ŀ | PARAMETER | CONDITIONS | T _A † | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| \/. | Threshold voltogs | | 25°C | 2.8 | 3.3 | 3.8 | 2.8 | 3.3 | 3.8 | 2.8 | 3.3 | 3.8 | V |
| VIT | Threshold voltage | | Full range | 2.7 | | 3.9 | 2.7 | | 3.9 | 2.7 | | 3.9 | V |
| 1 | Threshold current | | 25°C | | 10 | | | 10 | | | 10 | | - A |
| ΊΤ | Threshold current | | MAX | | 75 | | | 150 | | | 5000 | | pА |
| V. (== 1 =) | Trigger voltage | | 25°C | 1.36 | 1.66 | 1.96 | 1.36 | 1.66 | 1.96 | 1.36 | 1.66 | 1.96 | V |
| V _I (TRIG) | rrigger voltage | | Full range | 1.26 | | 2.06 | 1.26 | | 2.06 | 1.26 | | 2.06 | V |
| lummun. | Trigger ourrent | | 25°C | | 10 | | | 10 | | | 10 | | pА |
| l(TRIG) | Trigger current | | MAX | | 75 | | | 150 | | | 5000 | | pΑ |
| V | Reset voltage | | 25°C | 0.4 | 1.1 | 1.5 | 0.4 | 1.1 | 1.5 | 0.4 | 1.1 | 1.5 | V |
| V _I (RESET) | Reset voltage | | Full range | 0.3 | | 1.8 | 0.3 | | 1.8 | 0.3 | | 1.8 | V |
| t | Reset current | | 25°C | | 10 | | | 10 | | | 10 | | - 4 |
| I(RESET) | Reset current | | MAX | | 75 | | | 150 | | | 5000 | | pА |
| | Control voltage (open circuit) as a percentage of supply voltage | | MAX | | 66.7% | | | 66.7% | | | 66.7% | | |
| | Discharge switch | | 25°C | | 0.14 | 0.5 | | 0.14 | 0.5 | | 0.14 | 0.5 | ., |
| | on-state voltage | $I_{OL} = 10 \text{ mA}$ | Full range | | | 0.6 | | | 0.6 | | | 0.6 | V |
| | Discharge switch | | 25°C | | 0.1 | | | 0.1 | | | 0.1 | | 4 |
| | off-state current | | MAX | | 0.5 | | | 120 | | | 120 | | nA |
| ., | High-level output | | 25°C | 4.1 | 4.8 | | 4.1 | 4.8 | | 4.1 | 4.8 | | ., |
| VOH | voltage | $I_{OH} = -1 \text{ mA}$ | Full range | 4.1 | | | 4.1 | | | 4.1 | | | V |
| | | | 25°C | | 0.21 | 0.4 | | 0.21 | 0.4 | | 0.21 | 0.4 | |
| | | $I_{OL} = 8 \text{ mA}$ | Full range | | | 0.5 | | | 0.5 | | | 0.6 | |
| V | Low-level output | | 25°C | | 0.13 | 0.3 | | 0.13 | 0.3 | | 0.13 | 0.3 | ., |
| V _{OL} | voltage | $I_{OL} = 5 \text{ mA}$ | Full range | | | 0.4 | | | 0.4 | | | 0.45 | V |
| | | 1 22 1 | 25°C | | 0.08 | 0.3 | | 0.08 | 0.3 | | 0.08 | 0.3 | |
| | | $I_{OL} = 3.2 \text{ mA}$ | Full range | | | 0.35 | | | 0.35 | | | 0.4 | |
| 1 | Cumply surrent | See Note 2 | 25°C | | 170 | 350 | | 170 | 350 | | 170 | 350 | |
| IDD | Supply current | See Note 2 | Full range | | | 500 | | | 600 | | | 700 | μΑ |

[†] Full range is 0°C to 70°C the for TLC555C, -40°C to 85°C for the TLC555I, -40°C to 125°C for the TLC555Q, and -55°C to 125°C for the TLC555M. For conditions shown as MAX, use the appropriate value specified in the recommended operating conditions table.

NOTE 2: These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.



electrical characteristics at specified free-air temperature, V_{DD} = 15 V

| | ADAMETED | TEST | - + | - | TLC555C | | | TLC555I | | TLC55 | 5Q, TLC | 555M | |
|-----------------------|--|---------------------------|------------------|------|---------|-------|------|---------|-------|-------|---------|-------|------|
| Р | ARAMETER | CONDITIONS | T _A † | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| V | Threehold veltage | | 25°C | 9.45 | 10 | 10.55 | 9.45 | 10 | 10.55 | 9.45 | 10 | 10.55 | V |
| V _{IT} | Threshold voltage | | Full range | 9.35 | | 10.65 | 9.35 | | 10.65 | 9.35 | | 10.65 | V |
| 1 | Threshold current | | 25°C | | 10 | | | 10 | | | 10 | | - ^ |
| ^I IT | Threshold current | | MAX | | 75 | | | 150 | | | 5000 | | pA |
| V | Triages veltage | | 25°C | 4.65 | 5 | 5.35 | 4.65 | 5 | 5.35 | 4.65 | 5 | 5.35 | V |
| V _I (TRIG) | Trigger voltage | | Full range | 4.55 | | 5.45 | 4.55 | | 5.45 | 4.55 | | 5.45 | V |
| 1 | Trigger current | | 25°C | | 10 | | | 10 | | | 10 | | - ^ |
| l(TRIG) | rngger current | | MAX | | 75 | | | 150 | | | 5000 | | pA |
| V | Danat walkana | | 25°C | 0.4 | 1.1 | 1.5 | 0.4 | 1.1 | 1.5 | 0.4 | 1.1 | 1.5 | V |
| VI(RESET) | Reset voltage | | Full range | 0.3 | | 1.8 | 0.3 | | 1.8 | 0.3 | | 1.8 | V |
| 1 | Decet current | | 25°C | | 10 | | | 10 | | | 10 | | - ^ |
| I(RESET) | Reset current | | MAX | | 75 | | | 150 | | | 5000 | | pА |
| | Control voltage (open circuit) as a percentage of supply voltage | | MAX | | 66.7% | | | 66.7% | | | 66.7% | | |
| | Discharge switch | | 25°C | | 0.77 | 1.7 | | 0.77 | 1.7 | | 0.77 | 1.7 | ., |
| | on-state voltage | I _{OL} = 100 mA | Full range | | | 1.8 | | | 1.8 | | | 1.8 | V |
| | Discharge switch | | 25°C | | 0.1 | | | 0.1 | | | 0.1 | | |
| | off-state current | | MAX | | 0.5 | | | 120 | | | 120 | | nA |
| | | | 25°C | 12.5 | 14.2 | | 12.5 | 14.2 | | 12.5 | 14.2 | | |
| | | $I_{OH} = -10 \text{ mA}$ | Full range | 12.5 | | | 12.5 | | | 12.5 | | | |
| ., | High-level output | | 25°C | 13.5 | 14.6 | | 13.5 | 14.6 | | 13.5 | 14.6 | | V |
| VOH | voltage | $I_{OH} = -5 \text{ mA}$ | Full range | 13.5 | | | 13.5 | | | 13.5 | | | V |
| | | 4 4 | 25°C | 14.2 | 14.9 | | 14.2 | 14.9 | | 14.2 | 14.9 | | |
| | | $I_{OH} = -1 \text{ mA}$ | Full range | 14.2 | | | 14.2 | | | 14.2 | | | |
| | | 100 1 | 25°C | | 1.28 | 3.2 | | 1.28 | 3.2 | | 1.28 | 3.2 | |
| | | I _{OL} = 100 mA | Full range | | | 3.6 | | | 3.7 | | | 3.8 | |
| | Low-level output | I | 25°C | | 0.63 | 1 | | 0.63 | 1 | | 0.63 | 1 | V |
| VOL | voltage | I _{OL} = 50 mA | Full range | | | 1.3 | | | 1.4 | | | 1.5 | V |
| | | Ja: - 10 m/ | 25°C | | 0.12 | 0.3 | | 0.12 | 0.3 | | 0.12 | 0.3 | |
| | | I _{OL} = 10 mA | Full range | | | 0.4 | | | 0.4 | | | 0.45 | |
| <u> </u> | Cumply ourrant | Coo Note 2 | 25°C | | 360 | 600 | | 360 | 600 | | 360 | 600 | |
| IDD | Supply current | See Note 2 | Full range | | | 800 | | | 900 | | | 1000 | μΑ |

[†] Full range is 0°C to 70°C for TLC555C, -40°C to 85°C for TLC555I, -40°C to 125°C for the TLC555Q, and -55°C to 125°C for TLC555M. For conditions shown as MAX, use the appropriate value specified in the recommended operating conditions table.

NOTE 2: These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.

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operating characteristics, V_{DD} = 5 V, T_A = 25°C (unless otherwise noted)

| - | PARAMETER | TEST | TEST CONDITIONS | | | MAX | UNIT |
|------------------|---|--|--|-----|-----|-----|------|
| | Initial error of timing interval‡ | $V_{DD} = 5 \text{ V to } 15 \text{ V},$ | $R_A = R_B = 1 \text{ k}\Omega \text{ to } 100 \text{ k}\Omega,$ | | 1% | 3% | |
| | Supply voltage sensitivity of timing interval | $C_T = 0.1 \mu F$, | See Note 3 | | 0.1 | 0.5 | %/V |
| t _r | Output pulse rise time | D 40.MO | 0 40 = F | | 20 | 75 | |
| tf | Output pulse fall time | $R_L = 10 M\Omega$, | C _L = 10 pF | | 15 | 60 | ns |
| f _{max} | Maximum frequency in astable mode | $R_A = 470 \Omega,$ $C_T = 200 pF,$ | $R_B = 200 \Omega$, See Note 3 | 1.2 | 2.1 | | MHz |

[‡] Timing interval error is defined as the difference between the measured value and the average value of a random sample from each process run.

electrical characteristics at V_{DD} = 5 V, T_A = 25°C

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------------|--|---------------------------|------|-------|------|------|
| V_{IT} | Threshold voltage | | 2.8 | 3.3 | 3.8 | V |
| I _I T | Threshold current | | | 10 | | pA |
| V _I (TRIG) | Trigger voltage | | 1.36 | 1.66 | 1.96 | V |
| I _{I(TRIG)} | Trigger current | | | 10 | | pА |
| V _I (RESET) | Reset voltage | | 0.4 | 1.1 | 1.5 | V |
| I _I (RESET) | Reset current | | | 10 | | pA |
| | Control voltage (open circuit) as a percentage of supply voltage | | | 66.7% | | |
| | Discharge switch on-state voltage | I _{OL} = 10 mA | | 0.14 | 0.5 | V |
| | Discharge switch off-state current | | | 0.1 | | nA |
| Vон | High-level output voltage | I _{OH} = - 1 mA | 4.1 | 4.8 | | V |
| | | I _{OL} = 8 mA | | 0.21 | 0.4 | |
| VOL | Low-level output voltage | $I_{OL} = 5 \text{ mA}$ | | 0.13 | 0.3 | V |
| | | $I_{OL} = 3.2 \text{ mA}$ | | 0.08 | 0.3 | |
| I _{DD} | Supply current | See Note 2 | | 170 | 350 | μΑ |

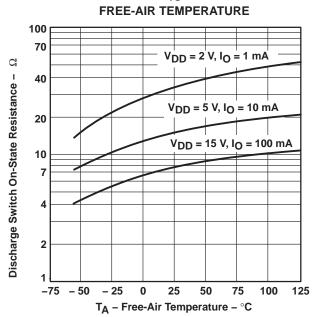
NOTE 2: These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.



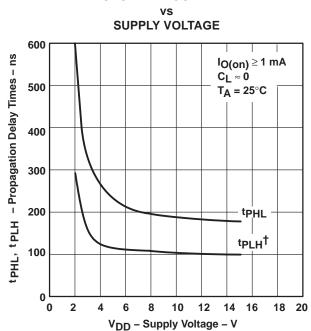
NOTE 3: R_A , R_B , and C_T are as defined in Figure 1.

TYPICAL CHARACTERISTICS

DISCHARGE SWITCH ON-STATE RESISTANCE vs



PROPAGATION DELAY TIMES TO DISCHARGE OUTPUT FROM TRIGGER AND THRESHOLD SHORTED TOGETHER

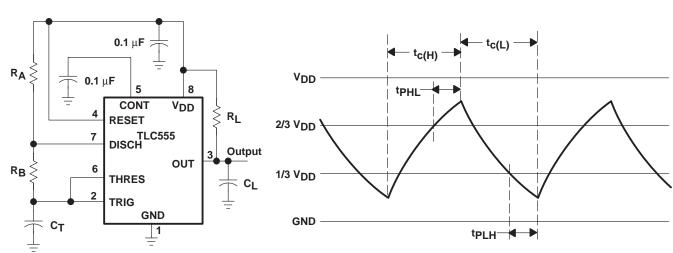


† The effects of the load resistance on these values must be taken into account separately.

Figure 1

Figure 2

APPLICATION INFORMATION



Pin numbers shown are for all packages except the FK package.

CIRCUIT

TRIGGER AND THRESHOLD VOLTAGE WAVEFORM

Figure 3. Astable Operation



APPLICATION INFORMATION

Connecting TRIG to THRES, as shown in Figure 3, causes the timer to run as a multivibrator. The capacitor C_T charges through R_A and R_B to the threshold voltage level (approximately 0.67 V_{DD}) and then discharges through R_B only to the value of the trigger voltage level (approximately 0.33 V_{DD}). The output is high during the charging cycle ($t_{C(H)}$) and low during the discharge cycle ($t_{C(L)}$). The duty cycle is controlled by the values of R_A , R_B , and C_T as shown in the equations below.

$$\begin{array}{l} t_{c(H)} \ \approx \ C_T \, (R_A \ + \ R_B) \ \text{ln 2} \quad (\text{ln 2} = 0.693) \\ t_{c(L)} \ \approx \ C_T \, R_B \ \text{ln 2} \\ \text{Period} \ = \ t_{c(H)} \ + \ t_{c(L)} \ \approx \ C_T \, (R_A \ + \ 2R_B) \ \text{ln 2} \\ \text{Output driver duty cycle} \ = \ \frac{t_{c(L)}}{t_{c(H)} \ + \ t_{c(L)}} \ \approx \ 1 - \frac{R_B}{R_A \ + \ 2R_B} \\ \text{Output waveform duty cycle} \ = \ \frac{t_{c(H)}}{t_{c(H)} \ + \ t_{c(L)}} \ \approx \ \frac{R_B}{R_A \ + \ 2R_B} \end{array}$$

The 0.1-μF capacitor at CONT in Figure 3 decreases the period by about 10%.

The formulas shown above do not allow for any propagation delay times from the TRIG and THRES inputs to DISCH. These delay times add directly to the period and create differences between calculated and actual values that increase with frequency. In addition, the internal on-state resistance r_{on} during discharge adds to R_{B} to provide another source of timing error in the calculation when R_{B} is very low or r_{on} is very high.

The equations below provide better agreement with measured values.

$$t_{c(H)} = C_{T}(R_{A} + R_{B}) \ln \left[3 - \exp\left(\frac{-t_{PLH}}{C_{T}(R_{B} + r_{on})}\right) \right] + t_{PHL}$$

$$t_{c(L)} = C_{T}(R_{B} + r_{on}) \ln \left[3 - \exp\left(\frac{-t_{PHL}}{C_{T}(R_{A} + R_{B})}\right) \right] + t_{PLH}$$

These equations and those given earlier are similar in that a time constant is multiplied by the logarithm of a number or function. The limit values of the logarithmic terms must be between In 2 at low frequencies and In 3 at extremely high frequencies. For a duty cycle close to 50%, an appropriate constant for the logarithmic terms can be substituted

with good results. Duty cycles less than 50%
$$\frac{{}^t c(H)}{{}^t c(H)}$$
 require that $\frac{{}^t c(H)}{{}^t c(L)}$ <1 and possibly $R_A \le r_{on}$. These

conditions can be difficult to obtain.

In monostable applications, the trip point on TRIG can be set by a voltage applied to CONT. An input voltage between 10% and 80% of the supply voltage from a resistor divider with at least 500-μA bias provides good results.







PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Pe |
|------------------|------------|--------------|--------------------|------|-------------|----------------------------|----------------------|--------------|
| 5962-89503012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pk |
| 5962-8950301PA | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pk |
| TLC555CD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CDG4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CDRG4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CP | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pk |
| TLC555CPE4 | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pk |
| TLC555CPSR | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CPSRG4 | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CPW | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CPWG4 | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CPWR | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555CPWRG4 | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555ID | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555IDG4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555IDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555IDRG4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260 |
| TLC555IP | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pk |



PACKA

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Pea |
|------------------|------------|--------------|--------------------|------|-------------|----------------------------|----------------------|---------------|
| TLC555IPE4 | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg |
| TLC555MFKB | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg |
| TLC555MJG | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg |
| TLC555MJGB | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 | N / A for Pkg |
| TLC555MP | OBSOLETE | PDIP | Р | 8 | | TBD | Call TI | Call TI |
| TLC555QDR | ACTIVE | SOIC | D | 8 | 2500 | TBD | CU NIPDAU | Level-1-2200 |
| TLC555QDRG4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-2600 |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retard in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF TLC555, TLC555M:



PACKA

• Automotive: TLC555-Q1, TLC555-Q1

Military: TLC555M

NOTE: Qualified Version Definitions:

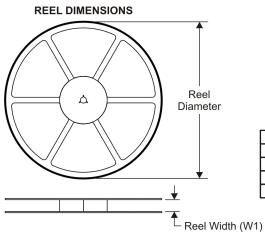
- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military QML certified for Military and Defense Applications



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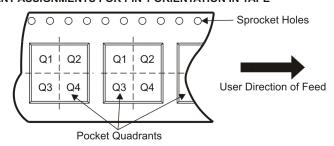
TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

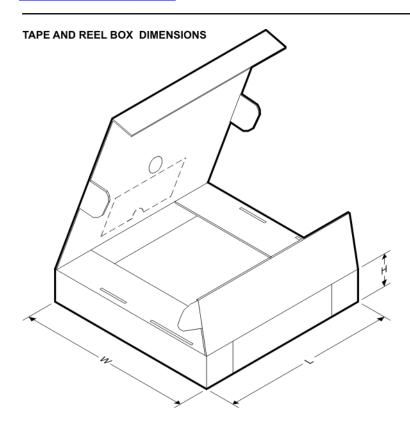


*All dimensions are nominal

| "All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| TLC555CDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| TLC555CPSR | SO | PS | 8 | 2000 | 330.0 | 16.4 | 8.2 | 6.6 | 2.5 | 12.0 | 16.0 | Q1 |
| TLC555CPWR | TSSOP | PW | 14 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |
| TLC555IDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| TLC555QDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |

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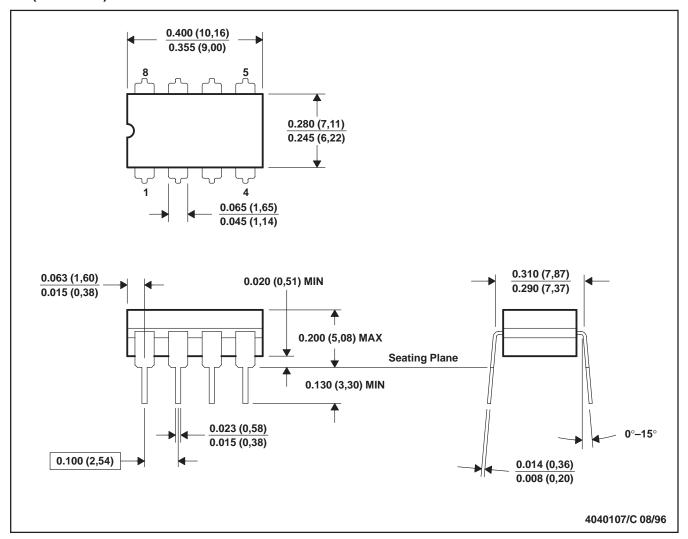


*All dimensions are nominal

| 7 til diffictioloris are florilitat | | | | | | | |
|-------------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| TLC555CDR | SOIC | D | 8 | 2500 | 340.5 | 338.1 | 20.6 |
| TLC555CPSR | SO | PS | 8 | 2000 | 346.0 | 346.0 | 33.0 |
| TLC555CPWR | TSSOP | PW | 14 | 2000 | 346.0 | 346.0 | 29.0 |
| TLC555IDR | SOIC | D | 8 | 2500 | 340.5 | 338.1 | 20.6 |
| TLC555QDR | SOIC | D | 8 | 2500 | 346.0 | 346.0 | 29.0 |

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE



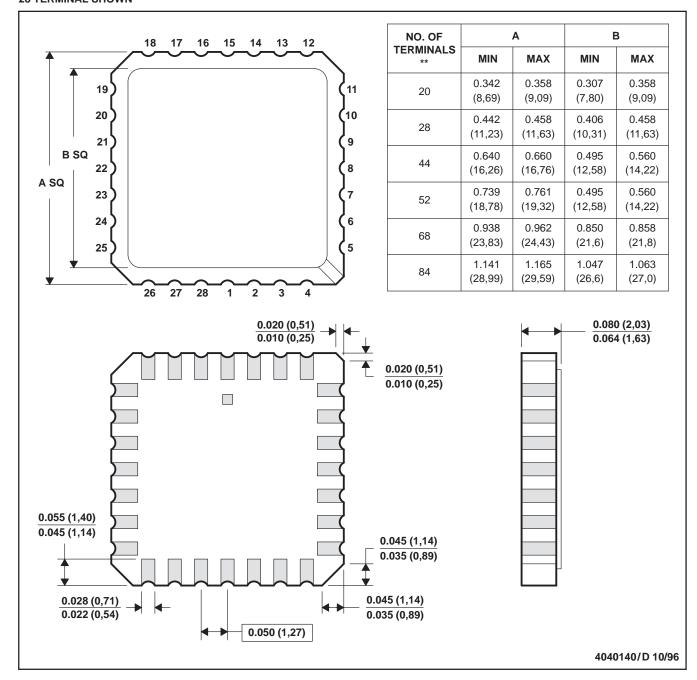
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



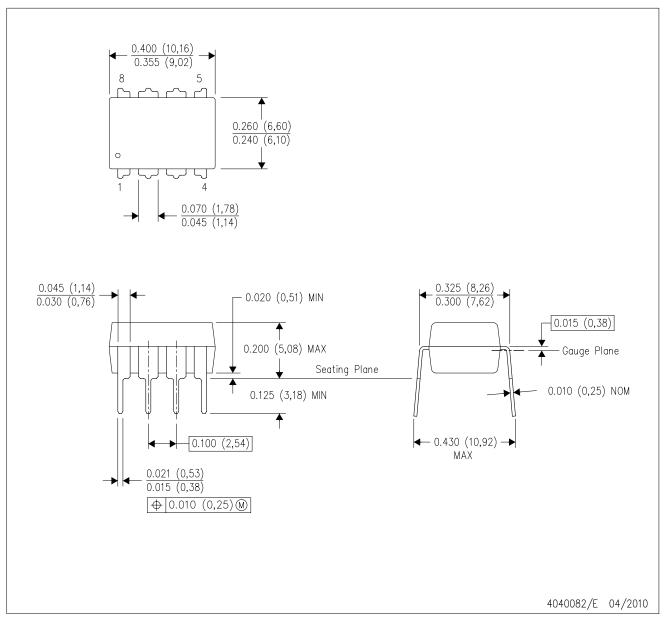
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



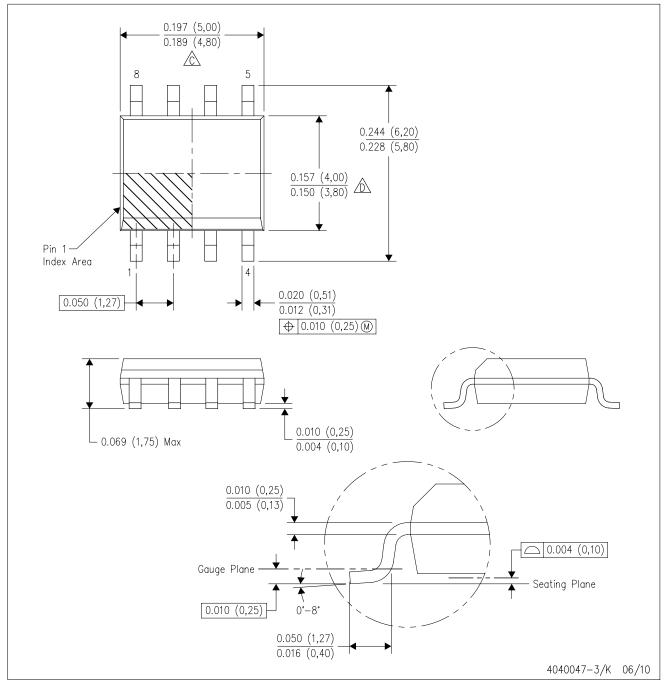
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



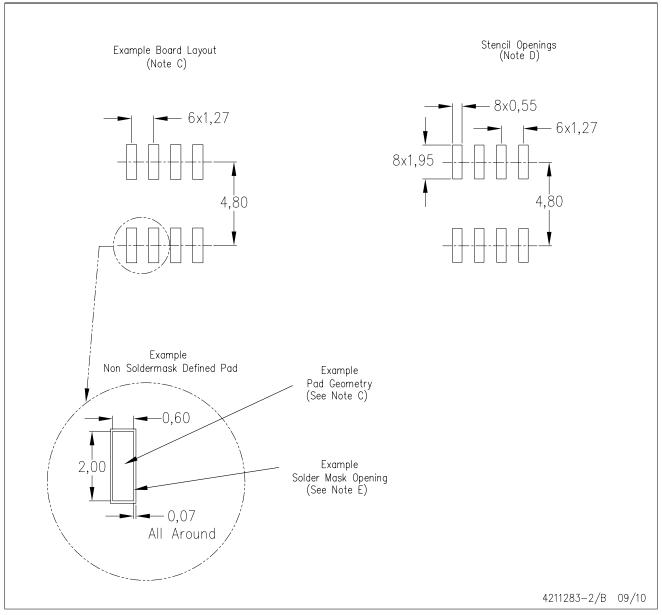
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.



D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES:

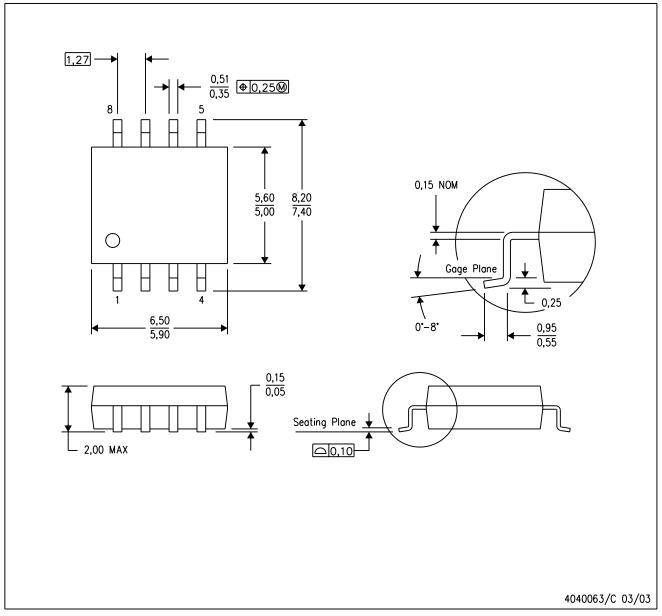
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

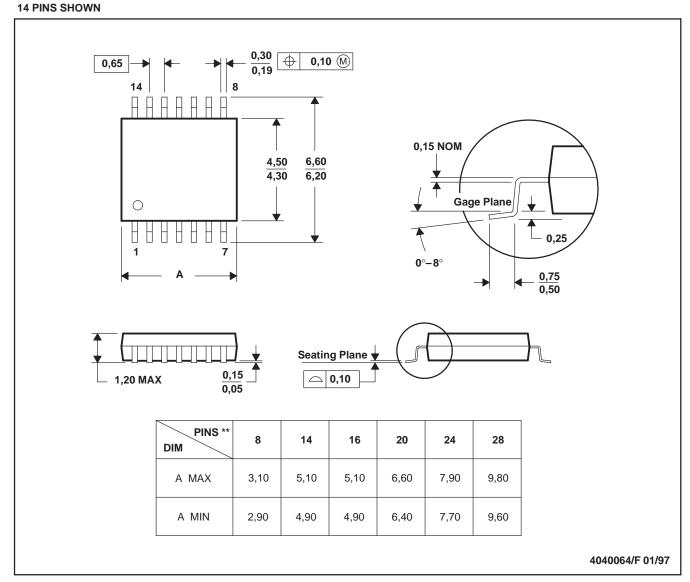
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

(...

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

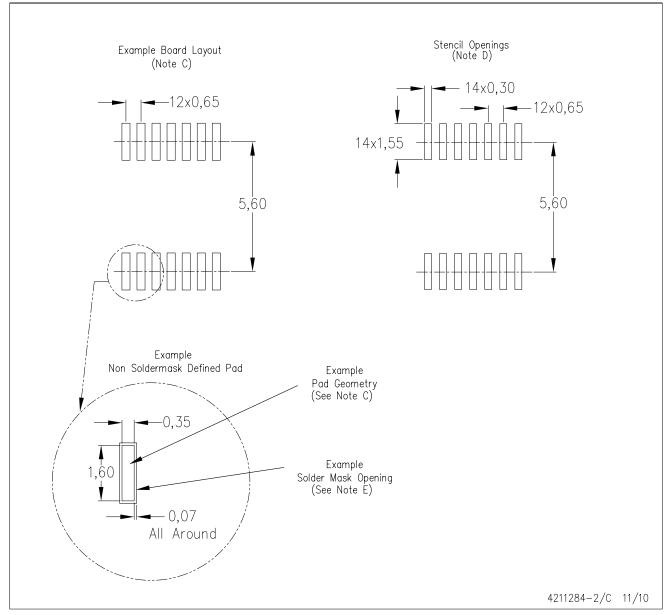
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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